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(54) Title: AN APPARATUS FOR SUPPLYING BREATHABLE GAS

(57) Abstract

An apparatus (1) for supplying breathable gas is disclosed. The apparatus (1) includes a relatively rigid external housing (2), at least one noise producing component (3, 4, 5, 6) Internal the housing (2), and a thin flexible enclosure (8) substantially sealed around the noise producing components (3, 4, 5, 6). A method of assembling the apparatus (1) is also disclosed. The method comprises the steps of assembling the noise producing component(s) (3, 4, 5, 6) into a sub-assembly, placing the sub-assembly into the interio (9) of the thin flexible enclosure (8) through an opening therein, substantially scaling the opening, and placing the flexible enclosure (8) within the external housing (2).

